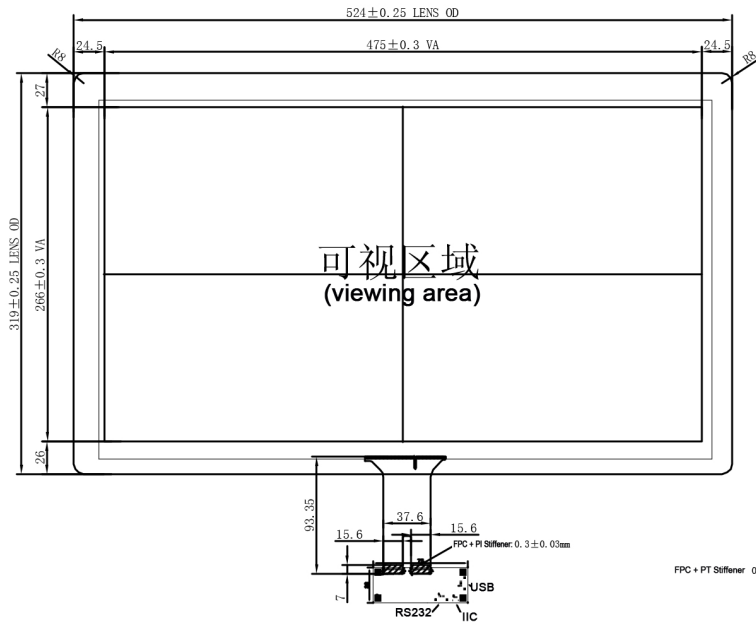


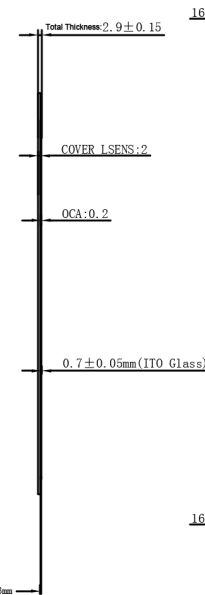
# 8150盖板+8223 SENSOR +8133 FPC

REV	MARK	HISTORY	DATE	NAME
REV.1	—	—	2019.01.18	LBC

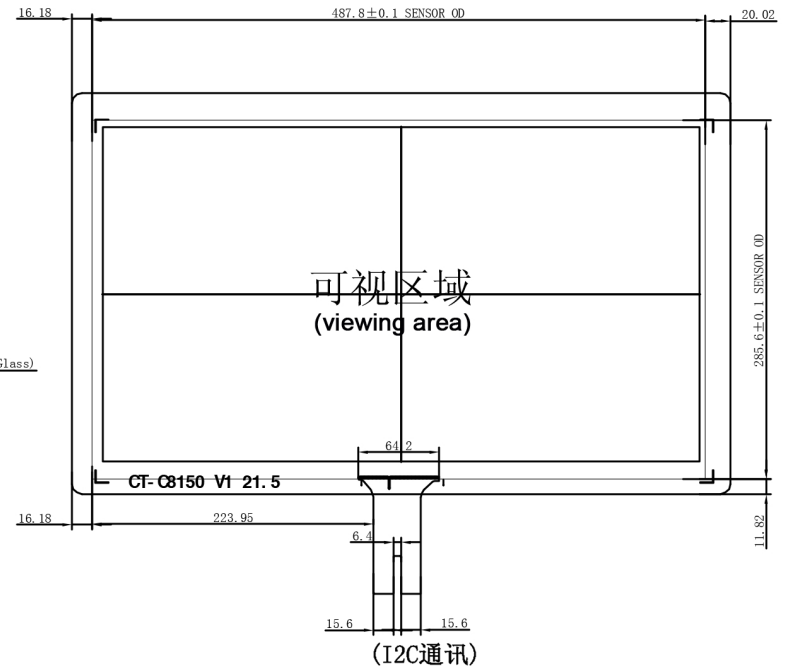
front view



side view



back view



Notes:

1. Structure: G+G;
2. Type: COB ;Controller: ILI2510P C3P1V1
3. Transmittance:  $\geq 85\%$
4. Hardness : 6H
5. Operating conditions:  $-10^{\circ}\text{C} \sim +60^{\circ}\text{C}$ ,  $\leq 85\% \text{RH}$
6. Storage conditions:  $-10^{\circ}\text{C} \sim +65^{\circ}\text{C}$ ,  $\leq 85\% \text{RH}$
7. Unspecified tolerance:  $\pm 0.2 \text{mm}$
8. All materials in the drawing comply with the RoHS

(USB通讯)

PIN	定义
1	VBUSIN
2	DN/D-
3	DP/D+
4	GNDIN

(I2C通讯)

PIN	定义
1	VDD33
2	I2C_SDA
3	I2C_SCL
4	I2C_INT
5	RSTN
6	GNDIN

(RS232通讯)

PIN	定义
1	VBUSIN/5V
2	232RXD
3	232TXD
4	GNDIN

C8395V1 21.5				SHEET	UNIT	SCALE	1st ANGLE PROJECTION
				1 of 1	mm	1:1	
DESIGN	LBC	DATE	2019.01.18				
CHECK		DATE					